Plastic Medium-Power Silicon Transistors

These devices are designed for general-purpose amplifier and low-speed switching applications.

Features

- High DC Current Gain $h_{FE} = 2500$ (Typ) @ $I_C = 4.0$ Adc
- Collector-Emitter Sustaining Voltage @ 100 mAdc

V_{CEO(sus)} = 60 Vdc (Min) – 2N6387 = 80 Vdc (Min) – 2N6388

• Low Collector-Emitter Saturation Voltage -

 $V_{CE(sat)} = 2.0 \text{ Vdc (Max)} @ I_C$ = 5.0 Adc - 2N6387, 2N6388

- Monolithic Construction with Built-In Base-Emitter Shunt Resistors
- TO-220AB Compact Package
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS (Note 1)

Rating		Symbol	Value	Unit
Collector-Emitter Voltage	2N6387 2N6388	V _{CEO}	60 80	Vdc
Collector-Base Voltage	2N6387 2N6388	V _{CB}	60 80	Vdc
Emitter-Base Voltage		V _{EB}	5.0	Vdc
Collector Current – Continuous – Peak		I _C	10 15	Adc
Base Current		Ι _Β	250	mAdc
Total Power Dissipation @ T _C = Derate above 25°C	25°C	P _D	65 0.52	W W/°C
Total Power Dissipation @ T _A = 2 Derate above 25°C	25°C	P _D	2.0 0.016	W W/°C
Operating and Storage Junction, Temperature Range	T _J , T _{stg}	-65 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

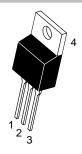
Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.92	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W



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DARLINGTON NPN SILICON POWER TRANSISTORS 8 AND 10 AMPERES 65 WATTS, 60 – 80 VOLTS



TO-220 CASE 221A STYLE 1

MARKING DIAGRAM



2N638x = Device Code

x = 7 or 8

G = Pb-Free Package A = Assembly Location

Y = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
2N6387G	TO-220 (Pb-Free)	50 Units / Rail
2N6388G	TO-220 (Pb-Free)	50 Units / Rail

^{1.} Indicates JEDEC Registered Data.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

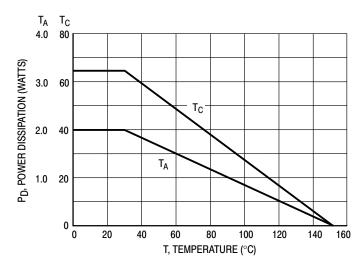


Figure 1. Power Derating

FLECTRICAL CHARACTERISTICS (To = 25°C unless otherwise noted) (Note 2)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (Note 3) $(I_C = 200 \text{ mAdc}, I_B = 0)$	2N6387 2N6388	V _{CEO(sus)}	60 80	_ _	Vdc
Collector Cutoff Current $(V_{CE} = 60 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 80 \text{ Vdc}, I_B = 0)$	2N6387 2N6388	I _{CEO}	_ _	1.0 1.0	mAdc
Collector Cutoff Current $(V_{CE} = 60 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc})$ $(V_{CE} - 80 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc})$ $(V_{CE} - 80 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}, T_{C} = 125^{\circ}\text{C})$ $(V_{CE} = 80 \text{ Vdc}, V_{EB(off)} = 1.5 \text{ Vdc}, T_{C} = 125^{\circ}\text{C})$	2N6387 2N6388 2N6387 2N6388	I _{CEX}	- - -	300 300 3.0 3.0	μAdc mAdc
Emitter Cutoff Current ($V_{BE} = 5.0 \text{ Vdc}$, $I_{C} = 0$)		I _{EBO}	_	5.0	mAdc
ON CHARACTERISTICS (Note 3)			•	•	•
DC Current Gain		h _{FE}			_

DC Current Gain ($I_C = 5.0$ Adc, $V_{CE} = 3.0$ Vdc) ($I_C = 1.0$ Adc, $V_{CE} = 3.0$ Vdc)	2N6387, 2N6388 2N6387, 2N6388	h _{FE}	1000 100	20,000	-
Collector–Emitter Saturation Voltage ($I_C = 5.0$ Adc, $I_B = 0.01$ Adc) ($I_C = 10$ Adc, $I_B = 0.1$ Adc)	2N6387, 2N6388 2N6387, 2N6388	V _{CE(sat)}	- -	2.0 3.0	Vdc
Base–Emitter On Voltage ($I_C = 5.0$ Adc, $V_{CE} = 3.0$ Vdc) ($I_C = 10$ Adc, $V_{CE} = 3.0$ Vdc)	2N6387, 2N6388 2N6387, 2N6388	V _{BE(on)}	-	2.8 4.5	Vdc

DYNAMIC CHARACTERISTICS

Small–Signal Current Gain ($I_C = 1.0$ Adc, $V_{CE} = 5.0$ Vdc, $f_{test} = 1.0$ MHz)	h _{fe}	20	_	_	
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)	C _{ob}	_	200	pF	Ī
Small–Signal Current Gain (I _C = 1.0 Adc, V _{CE} = 5.0 Vdc, f = 1.0 kHz)	h _{fe}	1000	-	-	Ī

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Indicates JEDEC Registered Data.
Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

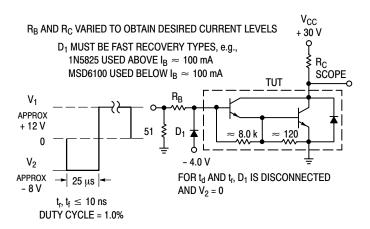


Figure 2. Switching Times Test Circuit

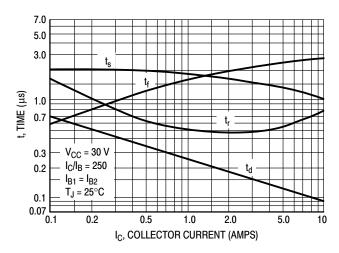


Figure 3. Switching Times

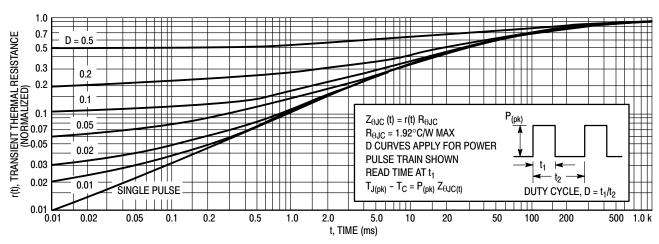


Figure 4. Thermal Response

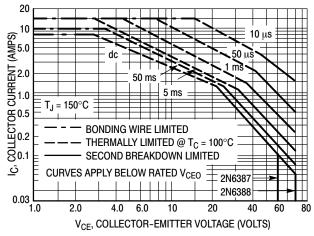


Figure 5. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)}=150^{\circ}C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)}<150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown

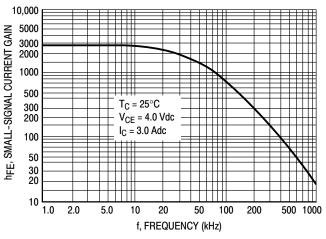


Figure 6. Small-Signal Current Gain

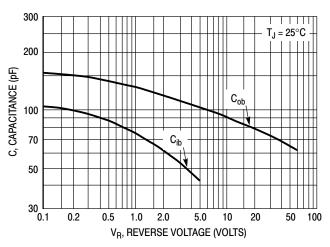


Figure 7. Capacitance

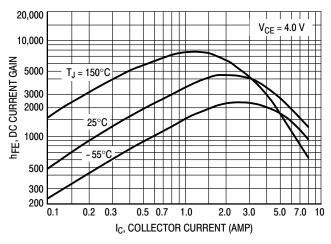


Figure 8. DC Current Gain

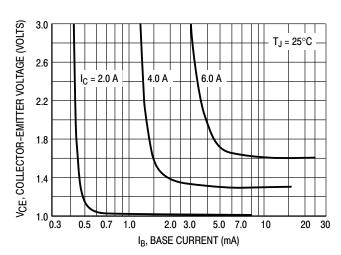


Figure 9. Collector Saturation Region

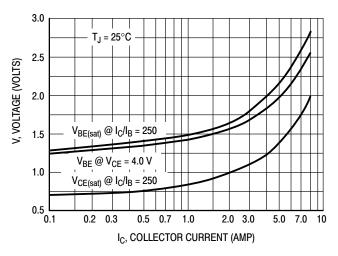


Figure 10. "On" Voltages

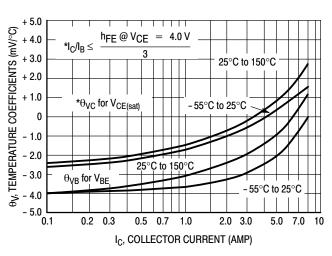


Figure 11. Temperature Coefficients

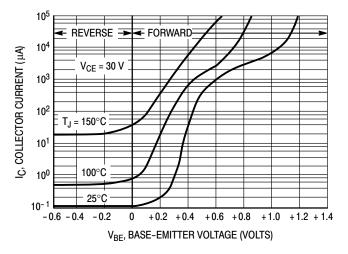


Figure 12. Collector Cut-Off Region

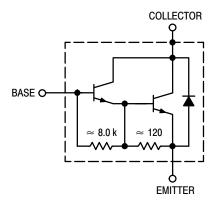
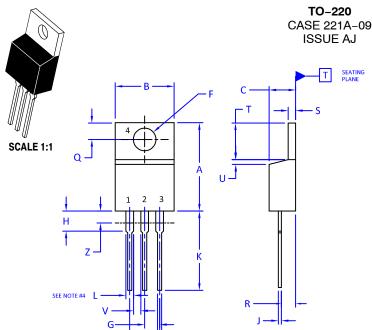


Figure 13. Darlington Schematic



DATE 05 NOV 2019

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMI	ETERS
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.	BASE	PIN 1.	BASE	PIN 1.	CATHODE	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	EMITTER	2.	ANODE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	COLLECTOR	3.	GATE	3.	GATE
4.	COLLECTOR	4.	EMITTER	4.	ANODE	4.	MAIN TERMINAL 2
STYLE 5:		STYLE 6:		STYLE 7:		STYLE 8:	
PIN 1.	GATE	PIN 1.	ANODE	PIN 1.	CATHODE	PIN 1.	CATHODE
2.	DRAIN	2.	CATHODE	2.	ANODE	2.	ANODE
3.	SOURCE	3.	ANODE	3.	CATHODE	3.	EXTERNAL TRIP/DELA
4.	DRAIN	4.	CATHODE	4.	ANODE	4.	ANODE
STYLE 9:		STYLE 10:		STYLE 11:		STYLE 12	:
PIN 1.	GATE	PIN 1.	GATE	PIN 1.	DRAIN	PIN 1.	MAIN TERMINAL 1
2.	COLLECTOR	2.	SOURCE	2.	SOURCE	2.	MAIN TERMINAL 2
3.	EMITTER	3.	DRAIN	3.	GATE	3.	GATE
4.	COLLECTOR	4.	SOURCE	4.	SOURCE	4.	NOT CONNECTED

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